



Product Change Notification

Change Notification #: 115723 - 00

Change Title: Intel® Server Board S2600KP and S2600TP
Product Family,
PCN 115723-00, Label,
Carton Package Label Change

Date of Publication: August 07, 2017

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

| | |
|---|-----------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | August 22, 2017 |
|---|-----------------|

Description of Change to the Customer:

The Intel® Server Board S2600KP and S2600TP Product Family listed in the “Products Affected/Intel Ordering Codes” table will undergo the following change on the baseboard carton package box:

- a) Add the Lithium Metal Battery label next to the shipping label

Please refer to the “Products Affected/Intel Ordering Codes” table below for a summary of TA changes.

Current carton package box:



Lithium metal battery label to be placed next to the shipping label:



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre Change TA | Post Change TA |
|--------------|--------|---------------|----------------|
| BBS2600KPR | 943789 | H37994-017 | H37994-018 |
| BBS2600KPFR | 943790 | H37995-017 | H37995-018 |
| BBS2600KPTR | 948036 | H78327-016 | H78327-017 |
| BBS2600TPR | 943944 | H48901-016 | H48901-017 |
| BBS2600TPFR | 943947 | H48902-016 | H48902-017 |
| BBS2600TPNR | 955259 | J56191-203 | J56191-204 |

PCN Revision History:

Date of Revision:
August 07, 2017

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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